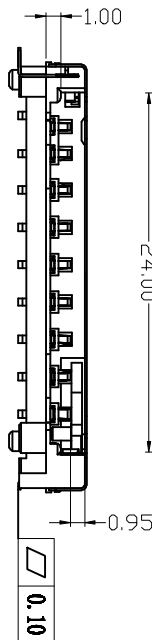
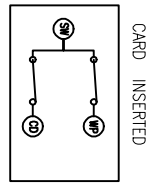
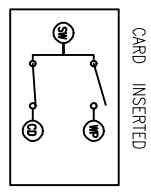
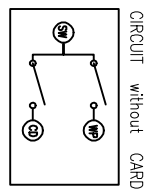


* 所有原材料质, 生产制程, 电检必须符合RoHS要求



TYPE	DIM.A
无垫高	0
垫高1.00	1.00
垫高1.50	1.50
垫高1.80	1.80
垫高2.00	2.00



- Write protect sw. Lock
- Status: Read only
- Write protect sw. Unlock
- Status: Write enable

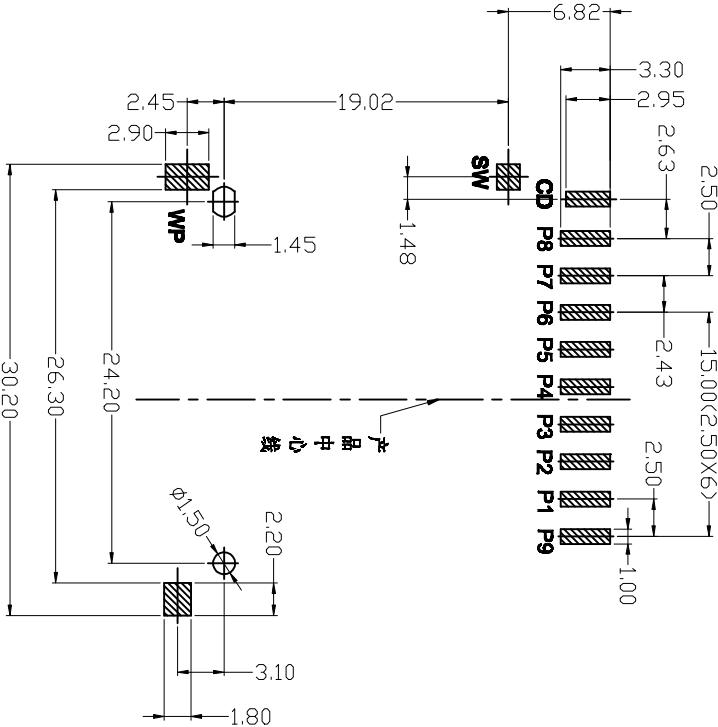
REVISION NO.	REV.
A	RN-100606

新发行图纸

PART NO.
0011XXBX 09 B

- A= 垫高0
- B= 垫高1.0
- C= 垫高1.5
- D= 垫高1.8
- E= 垫高2.0
- A= 项能区数150° 焊接脚数100° (符合RoHS制程)
- B= 项能区数150° 焊接脚数100° (符合RoHS制程)
- C= 项能区数150° 焊接脚数100° (符合RoHS制程)
- D= 项能区数150° 焊接脚数100° (符合RoHS制程)
- E= 项能区数150° 焊接脚数100° (符合RoHS制程)

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SD CARD PIN DESIGN			
Pin#	Name	Type	Description
1	CD/DAT3	I/O/PP	Card Detect/ Data Line[Bit3]
2	CMD	PP	Command/Response
3	Vss1	S	Supply voltage ground
4	VDD	S	Supply voltage
5	CLK	I	Clock
6	Vss2	S	Supply voltage ground
7	DAT0	I/O/PP	Data Line [Bit 0]
8	DAT1	I/O/PP	Data Line [Bit 1]
9	DAT2	I/O/PP	Data Line [Bit 2]

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic,
UL 94V-0.

Contact: Copper Alloy

Contact: Plated 50u" Ni Overall

Plated Au Selective Contact Area
Plated 100u" Sn Over Ni On Solder Area

Shell: Stainless steel

Electrical:

Current Rating :0.5mA AC/DC max.

Voltage Rating :125V AC/DC

Ambient Temperature Range : -20°C~+60°C

Storage Temperature Range : -40°C~+70°C

Ambient Humidity Range :95% R.H. Max.

Contact Resistance:100MΩ max.

Insulation Resistance:1000MΩ min./500VDC

Mating Cycles:10,000 Insertions

Usable Memory Card:

SD&MMC C I

深圳市鑫达通电子有限公司

A	RN-100606		新发行图纸		
REVISION NO.	REV. NO.		DESCRIPTION		
1					

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